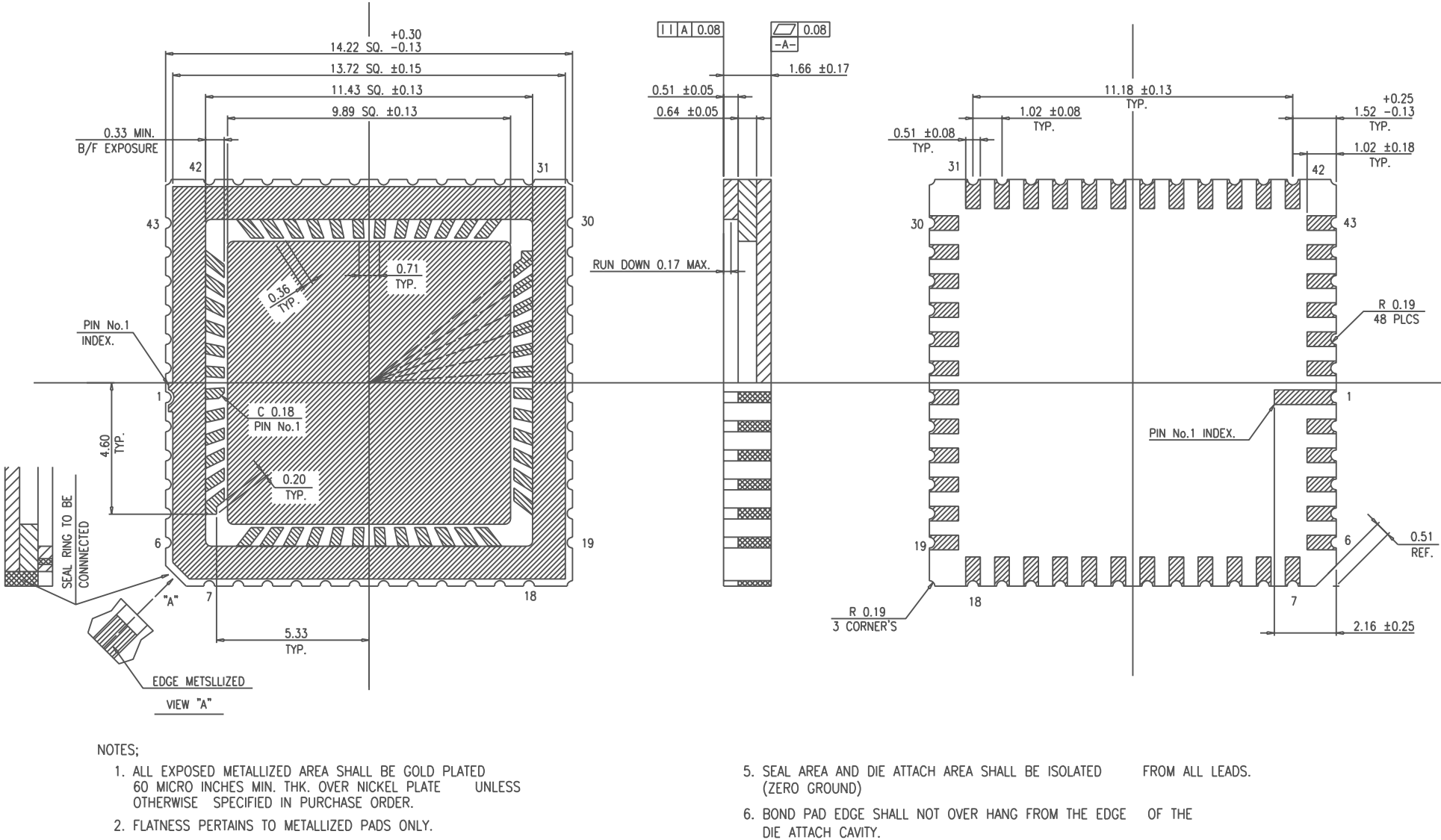

NOTES;

1. ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED 60 MICRO INCHES MIN. THK. OVER NICKEL PLATE UNLESS OTHERWISE SPECIFIED IN PURCHASE ORDER.
2. FLATNESS PERTAINS TO METALLIZED PADS ONLY.
3. LEAD TO LEAD LEAKAGE MUST NOT EXCEED 5 NANO AMPS AT 100V D.C.
4. LEAD RESISTANCE : 0.5 OHM MAX.
5. SEAL AREA AND DIE ATTACH AREA SHALL BE ISOLATED FROM ALL LEADS. (ZERO GROUND)
6. BOND PAD EDGE SHALL NOT OVER HANG FROM THE EDGE OF THE DIE ATTACH CAVITY.

MODIFICATIONS					
CHANGE	DATE	DRAWN	CHECKED	APPROVED	

NAME 48 LCC (.9.89 SQ. CAV.)
SCALE 10/1
MATERIAL KYOCERA A-440
TOLERANCES: UNLESS OTHERWISE SPECIFIED ±1% ± 0.13 THIRD ANGLE PROJECTION

KYOCERA
KYOCERA CORPORATION
KYOTO JAPAN

DRAWN	CHECKED	APPROVED	DATE
S.M	Y.S		'83-7-2

S=0
D=0
A00-48C

DRAWING NO. PB-34279
SHEE